

Final Product/Process Change Notification Document #: FPCN20626XBP Issue Date: 6 July 2015

Title of Change:	Final PCN for wire change from gold to copper and part number change.					
Proposed first ship date:	13 October 2015 or <i>Earlier upon customer approval</i>					
Contact information:	Contact your local ON Semiconductor Sales Office or < Yasuhiro Igarashi @onsemi.com>					
Samples:	Contact your local ON Semiconductor Sales Office					
Additional Reliability Data:	Contact your local ON Semiconductor Sales Office or < Kazutoshi.Kitazume@onsemi.com>.					
Type of notification:	This is a Final Product/Process Change Notification (FPCN) sent to customers. FPCNs are issued 90 days prior to implementation of the change. ON Semiconductor will consider this change accepted, unless an inquiry is made in writing within 30 days of delivery of this notice. To do so, contact <pcn.support@onsemi.com>.</pcn.support@onsemi.com>					
Change Part Identification:	Affected products will be identified with new part number (changing suffix to "-W").					
	PART_II		l ew Part_ID 1CH3474-TL-W			
Change category:	☐ Wafer Fab Change ☐ Assembly Change ☐ Test Change ☐ Other					
Change Sub-Category(s): □ Datasheet/Product Doc change □ Manufacturing Site Change/Addition □ Material Change □ Shipping/Packaging/Marking □ Manufacturing Process Change □ Other:						
Sites Affected: All site(s) not applicable ON Semiconductor site(s): External Foundry/Subcon site(s) ON Shenzhen, China						
Description and Purpose:						
This is a Final Process Change Notification to announce the content below: 1) Changing wire material from gold to copper 2) Changing part number from MCH3474-TL-H to MCH3474-TL-W.						
Reliability Data Summary:						
Test Conditions Read point Results						
Steady State Operating Life		Tj=150degC	Conditions	1000 hrs.	Pass	
High Temperature Reverse Bias		Ta=150degC,VR=max		1000 hrs.	Pass	
Temp Humidity Storage		Ta=85degC, RH=85%		1000 hrs.	Pass	
Temperature Cycle		Ta=-55degC to 150degC 30min each		100 cycles	Pass	
Pressure Cooker		Ta=121degC,2.03×10 ⁵ Pa,100%		50 hrs.	Pass	
High Temperature Storage		Ta=150degC		1000 hrs.	Pass	
Resistance to Soldering heat(Reflow)		Solder Temp.:260degC±5degC		1000 ms.	Pass	
Solderability		Solder Temp.: 245degC±5degC		5 s	Pass	
Electrical Characteristic Summary:						
Electrical characteristics are not impacted.						
List of Affected Standard Parts:						
Part Number				Qualification Vehicle		
MCH3474-TL-H				MCH6445-TL-W		

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